

Product / Process Change Notice

No.: Z200-PCN-DM201804-01-A Date: 04/13/2018 Change Title: W25QxxJV "J-Series" Industrial Plus grade to replace W25QxxBV "B-Series"/ W25QxxCV "C-Series"/ W25QxxDV "D-Series"/ W25QxxFV "F-Series" Industrial Plus grade SpiFlash® Memories Change item: ☑ Design ☐ Raw Material ☐ Wafer FAB ☐ Assembly ☐ Testing ☐ Packing ☐ Others Affected Product(s): Please refer to Table 1 in details. Description of Change(s) The W25QxxJV Industrial Plus grade SpiFlash® Memories use Winbond's 58nm Flash technology. It is functioncompatible with W25QxxBV "B-Series"/ W25QxxCV "C-Series"/ W25QxxDV "D-Series"/ W25QxxFV "F-Series" Industrial Plus grade devices offering improved performance, features and availability. Reason for Change(s): Improve features and Command backward compatible with W25QxxBV/ W25QxxCV/ W25QxxDV/W25QxxFV (same Superset Instruction Set) Impact of Change(s): (positive & negative) Form: No Change Fit: No Change Function: No Concern (Please refer to attachment I) Reliability: No Concern (Please refer to attachment II) Hazardous Substances: No Concern (Please refer to attachment III) Qualification Plan/ Results : Based on Winbond Serial Flash Reliability report, the new product meets our criteria and no quality concern (refer to Attachment II in details) Implementation Plan: Please refer to attachment IV for details. □ Date Code: onward □ Lot No: onward ☑ Proposed first ship date: Please refer to attachment IV Originator: (QA) Approval: (QA Approval: (QRA Hyhuang Dept. Manager) Director) Name: Betty Huang TEL:886-3-5678168 (ext.86549) FAX: 886-3-5796124 **Contact for Questions** Address: #539, Sec. 2, Wenxing Rd., Jhubei City, Hsinchu County 302, Taiwan & Concerns E-mail: Hyhuang8@winbond.com

Table No.: 1110-0001-08-A



Customer Comments:

Note: Please sign this notice, and return to Winbond contact within **30** days. If no response is received within **30** days, this Change Request will be assumed to meet your approval.

Major change: □ Approval	□ Disapproval	□ Conditional Approval :				
Minor change with customer notification: □ Recognition						
Comment:						
Date:						
Dept. name:						
Person in charge:						

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Table 1. The affected part no are list below.

W25Q16CVSNJG	W25Q32FVSSJQ	W25Q64FVSSJF	W25Q64CVTBJP	W25Q128BVEJG
W25Q16DVSNJG	W25Q32BVSFJG	W25Q64FVSSJQ	W25Q64FVTBJF	W25Q128FVEJF
W25Q16CVSSJG	W25Q32FVSFJF	W25Q64CVSFJG	W25Q64FVTCJF	W25Q128FVCJF
W25Q16DVSSJG	W25Q32BVZPJG	W25Q64FVSFJF	W25Q128FVSJF	W25Q256FVFJF
W25Q16DVZPJG	W25Q32FVZPJF	W25Q64CVZPJG	W25Q128FVSJQ	W25Q256FVFJQ
W25Q16DVUUJG	W25Q32FVZEJF	W25Q64FVZPJF	W25Q128BVFJG	W25Q256FVEJF
W25Q32BVSSJG	W25Q32FVTCJF	W25Q64FVZEJF	W25Q128FVFJF	W25Q256FVEJQ
W25Q32FVSSJF	W25Q64CVSSJG	W25Q64CVTBJG	W25Q128FVPJF	W25Q256FVCJF



Winbond Electronics Corporation

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Product Obsolescence Notice

W25QxxJV Industrial Plus grade SpiFlash Memories

Notification Date: April, 15, 2018

Dear Valued Customer,

This letter is to notify you of Winbond's intention to terminate production of the <u>W25QxxBV "B-Series"/</u> <u>W25QxxCV "C-Series"/ W25QxxDV "D-Series"/ W25QxxFV "F-Series" Industrial Plus grade SpiFlash® Memories</u>, and replace it with the <u>W25QxxJV Industrial Plus grade SpiFlash® Memories</u>. Replacement part numbers are listed below:

	Winbond ry Replacement PN 8nm J-Series)	Winbond Current PN (90nm C/D-Series)	Winbond Primary Replacement PN (58nm J-Series)	Winbond Current PN (90nm B-Series) (58nm F-Series)	Winbond Primary Replacement PN (58nm J-Series)	Winbond Current PN (90nm C-Series) (58nm F-Series)	Winbond Primary Replacement PN (58nm J-Series)	Winbond Current PN (90nm B-Series) (58nm F-Series)	Winbond Primary Replacement PN (58nm J-Series)	Winbond Current PN (58nm F-Series)
Par	JV ↓ t No. (16Mb)₽	Part No. (16Mb)	JV ↓ Part No. (32Mb)₽	Part No. (32Mb)	JV ↓ Part No. (64Mb)₽	Part No. (64Mb)	JV ↓ Part No. (128Mb)	Part No. (128Mb)	JV ↓ Part No. (256Mb)€	Part No. (256Mb)
	5Q16JVSNJQ↓ 5Q16JVSNJM₽	-	` `	W25Q32BVSSJG4 W25Q32FVSSJQ4 W25Q32FVSSJF	W25Q64JVSSJQ↓ W25Q64JVSSJM₽	W25Q64CVSSJG W25Q64FVSSJQ W25Q64FVSSJF W25Q64FVSSJG	W25Q128JVSJQ↓ W25Q128JVSJM≠	W25Q128FVSJQ W25Q128FVSJF	- 11	1 W25O256FVFJF+
	5Q16JVSSJQ↓ 5Q16JVSSJM∘	W25Q16CVSSJG- W25Q16DVSSJG-	'	W25Q32BV8FJG4 W25Q32FV8FJF	W25Q64JVSFJQ↓ W25Q64JVSFJM₽	W25Q64FVSSJG W25Q64CVSFJG W25Q64FVSFJF	W25Q128JVFJQ↓ W25Q128JVFJMa	W25Q128BVFJC W25Q128FVFJF	W25Q256JVEJM€	W25Q256FVEJF« W25Q256FVEJG«
	5Q16JVZPJQ↓ 5Q16JVZPJM∂	W25Q16DVZPJG-	W25Q32JVZPJQ₽	W25Q32BVZPJG W25Q32FVZPJF	W25Q64JVZPJQ↓ W25Q64JVZPJM₽	W25Q64CVZPJG W25Q64FVZPJF	II W25O128IVPIMa	W25Q128FVPJF	W25Q256JVCJQ4 W25Q256JVCJM4	I W25O256FVCJF ₄
	5Q16JVUUJQ↓ 5Q16JVUUJM∘	W25Q16DVUUJG	W25Q32JVZEJM₽	W25Q32FVZEJF←	W25Q64JVZEJQ↓ W25Q64JVZEJM¢	W25Q64FVZEJF₽	<u> </u>	W25Q128BVEJC W25Q128FVEJF		
			W25Q32JVTCJM₽	W25Q32FVTCJF←	W25Q64JVTBJQ↓ W25Q64JVTBJM↔	W25Q64CVTBJP W25Q64CVTBJP W25Q64FVTBJF	W25Q128JVCJM	L-W25O128FVCIE	3 43	
					W25Q64JVTCJQ₽	W25Q64FVTCJF	P			

The W25QxxJV device features:

Features

- a) Command backward compatible with <u>W25QxxBV/ W25QxxCV/ W25QxxDV/ W25QxxFV</u> (same Superset Instruction Set)
- b) Clock operation up to 133MHz
- c) Lower power consumption
- d) SPI with Single / Dual / Quad
- e) Flexible architecture with 4KB sectors

Please refer to the table below for your particular product last time order date and Winbond last shipment date and use this table to determine your last time buys and subsequent request dates. Winbond Electronics reserves the right to limit last time buy quantities based on capacity and material availability. Please notify Winbond as soon as possible if there are any concerns with these this schedule.

Part	Notification	Last Order	Last Ship	Part	Reliability	Mass
Number	Date	Date	Date	Number	Report	Production
W25QxxBV/						
W25QxxCV/	Jul./15/	Jan./15/	Jul./15/	W25QxxJV	Feb./15/	Sep./27/
W25QxxDV/	2018	2019	2019	W 23QXXJ V	2017	2017
W25QxxFV						

Table No.: 1260-0009-02-A



Eddy Hung

Eddy Kung

Assistant Vice President of Flash Marketing

Table No.: 1260-0009-02-A